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IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the

application.

1. (Currently Amended) A lithographic apparatus comprising:

a support structure configured to hold a patterning device, the patterning device

configured to pattern a projection beam with a pattern in its cross-section;

a substrate table configured to hold a substrate; and

a projection system configured to project the patterned beam onto a target portion of

the substrate, wherein a joint between an element of the projection system and its support

comprises an inorganic layer comprising (i) metal, (ii) ceramic, (iii) glass, or (iv) any

combination of (i) - (iii), and comprises glue protection.

(Original) A lithographic apparatus according to claim 1, further comprises a liquid 2.

supply system configured to at least partially fill a space between the projection system and

the substrate, with a liquid.

3. (Previously Presented) A lithographic apparatus according to claim 2, wherein the

element is configured to come into contact with the liquid.

4. (Cancelled)

5. (Cancelled)

(Original) A lithographic apparatus according to claim 1, wherein said joint comprises 6.

a direct bond.

7. (Original) A lithographic apparatus according to claim 1, wherein the joint was made

without heating.

8. (Original) A lithographic apparatus according to claim 1, wherein the joint was heat

treated.

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9. (Original) A lithographic apparatus according to claim 8, wherein the joint has been heat treated to 900°C.

- (Original) A lithographic apparatus according to claim 8, wherein the joint is made by 10. the interaction of clean surfaces.
- 11. (Original) A lithographic apparatus according to claim 8, wherein the joint is made by the interaction of clean surfaces, sealed with a low temperature glass solder and heat treated to 600°C.
- 12. (Original) A lithographic apparatus according to claim 8, wherein the element of the projection system and its support are doped with boron.
- 13. (Original) A lithographic apparatus according to claim 12, wherein the joint is made by the interaction of clean surfaces, sealed with a low temperature glass solder and heat treated to 600°C.
- 14. (Original) A lithographic apparatus according to claim 1, wherein the inorganic layer comprises a metal solder.
- (Original) A lithographic apparatus according to claim 14, wherein the metal solder is 15. indium.
- 16. (Original) A lithographic apparatus according to claim 1, wherein the element and its support are made of glass.
- 17. (Original) A lithographic apparatus according to claim 16, wherein the element and its support are made of fused silica.
- 18. (Previously Presented) A lithographic apparatus according to claim 1, wherein the joints between all parts of the projection system configured to be immersed in a liquid comprise an inorganic layer.

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19. (Original) A lithographic apparatus according to claim 1, wherein the element is a

lens.

20. (Previously Presented) A lithographic apparatus comprising:

a support structure configured to hold a patterning device, the patterning device

configured to pattern a projection beam with a pattern in its cross-section;

a substrate table configured to hold a substrate; and

a projection system configured to project the patterned beam onto a target portion of

the substrate, wherein a joint between an element of the projection system and its support

comprises a direct bond.

21. (Original) A lithographic apparatus according to claim 20, further comprises a liquid

supply system configured to at least partially fill a space between the projection system and

the substrate, with a liquid.

22. (Previously Presented) A lithographic apparatus according to claim 21, wherein the

element is configured to come into contact with the liquid.

23. (Previously Presented) A lithographic apparatus according to claim 20, wherein the

joint comprises (i) a metal layer, (ii) a ceramic layer, (iii) a glass layer, or (iv) any

combination of (i) - (iii).

24. (Original) A lithographic apparatus according to claim 23, wherein the joint

comprises a layer of glue protection.

25. (Original) A lithographic apparatus according to claim 20, wherein the joint was made

without heating.

26. (Original) A lithographic apparatus according to claim 20, wherein the joint was heat

treated.

27. (Original) A lithographic apparatus according to claim 26, wherein the joint has been

heat treated to 900°C.

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28. (Original) A lithographic apparatus according to claim 26, wherein the joint is made by the interaction of clean surfaces.

- 29. (Original) A lithographic apparatus according to claim 26, wherein the joint is made by the interaction of clean surfaces, sealed with a low temperature glass solder and heat treated to 600°C.
- 30. (Original) A lithographic apparatus according to claim 26, wherein the element of the projection system and its support are doped with boron.
- 31. (Original) A lithographic apparatus according to claim 30, wherein the joint is made by the interaction of clean surfaces, sealed with a low temperature glass solder and heat treated to 600°C.
- 32. (Original) A lithographic apparatus according to claim 20, wherein the joint comprises a layer of metal solder.
- 33. (Original) A lithographic apparatus according to claim 32, wherein the metal solder comprises indium.
- 34. (Original) A lithographic apparatus according to claim 20, wherein the element and its support are made of glass.
- 35. (Original) A lithographic apparatus according to claim 34, wherein the element and its support are made of fused silica.
- 36. (Previously Presented) A lithographic apparatus according to claim 20, wherein the joints between all parts of the projection system configured to be immersed in a liquid comprise an inorganic layer.
- 37. (Original) A lithographic apparatus according to claim 20, wherein the element is a lens.

- 38. (Currently Amended) A lithographic apparatus comprising:
- a support structure configured to hold a patterning device, the patterning device configured to pattern a projection beam with a pattern in its cross-section;
 - a substrate table configured to hold a substrate; and
- a projection system configured to project the patterned beam onto a target portion of the substrate, the projection system having a lens, a lens support and an inorganic material providing a fluid tight seal between the lens and the lens support wherein the seal was made without heating.
- 39. (Previously Presented) A lithographic apparatus according to claim 38, wherein the inorganic layer comprises (i) a metal layer, (ii) a ceramic layer, (iii) a glass layer, or (iv) any combination of (i) (iii).
- 40. (Original) A lithographic apparatus according to claim 38, further comprising a direct bond between the lens and the lens support.
- 41. (Original) A lithographic apparatus according to claim 38, wherein the lens and the lens support are made of glass.
- 42. (Previously Presented) A lithographic apparatus comprising:
- a support structure configured to hold a patterning device, the patterning device configured to pattern a projection beam with a pattern in its cross-section;
 - a substrate table configured to hold a substrate; and
- a projection system configured to project the patterned beam onto a target portion of the substrate, the projection system having a lens, a lens support and a direct bond providing a fluid tight seal between the lens and the lens support.
- 43. (Previously Presented) A lithographic apparatus according to claim 42, further comprising (i) a metal layer, (ii) a ceramic layer, (iii) a glass layer, or (iv) any combination of (i) (iii) at a joint between the lens and the lens support.

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44. (Original) A lithographic apparatus according to claim 42, wherein a joint between the lens and the lens support was heat treated.

- 45. (Original) A lithographic apparatus according to claim 42, wherein the lens and the lens support are made of glass.
- 46. (Currently Amended) An immersion projection system manufacturing method comprising joining an element of a projection system, that in use in a lithographic apparatus comes into contact with a liquid, with its support using an inorganic layer comprising (i) metal, (ii) ceramic, (iii) glass, or (iv) any combination of (i) (iii), and glue protection, direct bonding, or both.
- 47. (Cancelled)
- 48. (Original) The method according to claim 46, comprising heat treating the element and its support.
- 49. (Original) The method according to claim 48, wherein the joining comprises creating a joint by the interaction of a clean surface of the element and a clean surface of the support.
- 50. (Original) The method according to claim 46, wherein the inorganic layer comprises metal solder.
- 51. (Original) The method according to claim 46, wherein the element and its support are made of glass.
- 52. (Original) The method according to claim 51, wherein the element and its support are made of fused silica.
- 53. (Previously Presented) The method according to claim 46, comprising joining all elements of the projection system configured to be immersed in a liquid with their respective supports using an inorganic layer.